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219.40232X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Sarah E. KIM et al.

Serial No.: 10/077,967

Filed: February 20, 2002

For: A PROCESS OF VERTICALLY STACKING MULTIPLE WAFERS
SUPPORTING DIFFERENT ACTIVE INTEGRATED CIRCUIT (IC)
DEVICES

Group: 2822

INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR §1.97 & §1.98

Assistant Commissioner of Patents
Washington, D.C. 20231

April 16, 2002

Sir:

In the matter of the above-identified application, Applicants are submitting herewith copies of the documents listed in the attached form equivalent to Form PTO-1449 for the Examiner's consideration.

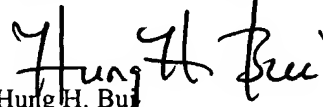
This information disclosure statement is being submitted within three months of the filing date.

Each of the documents listed on the attached form equivalent to Form PTO-1449 is in the English language.

It is respectfully requested that this information disclosure statement be considered by the Examiner.

Please charge any shortage in the fees due in connection with the filing of this paper,
including extension of time fees, to Deposit Account No. 01-2135 (219.40232X00) and please credit
any excess fees to such deposit account.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Hung H. Bui". The signature is fluid and cursive, with the first name "Hung" and last name "Bui" clearly distinguishable.

Hung H. Bui

Registration No. 40,415

ANTONELLI, TERRY, STOUT & KRAUS, LLP

HHB/srm
Attachments
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